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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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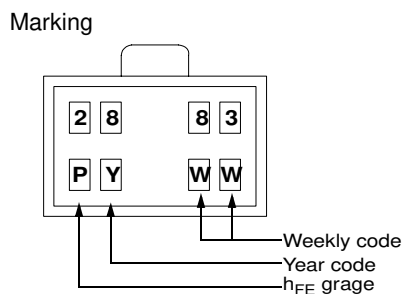
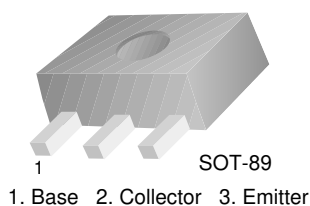


KSC2883

NPN Epitaxial Silicon Transistor

Low Frequency Power Amplifier

- 3W Output Application
- Collector Dissipation : $P_C=1\sim 2W$ in Mounted on Ceramic Board
- Complement to KSA1203



Absolute Maximum Ratings $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CB0}	Collector-Base Voltage	30	V
V_{CEO}	Collector-Emitter Voltage	30	V
V_{EBO}	Emitter-Base Voltage	5	V
I_C	Collector Current	1.5	A
I_B	Base Current	0.3	A
P_C	Collector Power Dissipation	500	mW
P_C^*		1,000	mW
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-55 ~ 150	$^\circ\text{C}$

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired. Mounted on Ceramic Board (250mm²×0.8mm)

Electrical Characteristics * $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 10\mu\text{A}, I_B = 0$	30			V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E = 1\text{mA}, I_C = 0$	5			V
I_{CB0}	Collector Cut-off Current	$V_{CB} = 30\text{V}, I_E = 0$			100	nA
I_{EBO}	Emitter Cut-off Current	$V_{BE} = 5\text{V}, I_C = 0$			100	nA
h_{FE}	DC Current Gain	$V_{CE} = 2\text{V}, I_C = 500\text{mA}$	100		320	
$V_{CE}(\text{sat})$	Collector-Emitter Saturation Voltage	$I_C = 1.5\text{A}, I_B = 30\text{mA}$			2.0	V
$V_{BE}(\text{on})$	Base-Emitter On Voltage	$V_{CE} = 2\text{V}, I_C = 500\text{mA}$			1.0	V
f_T	Current Gain Bandwidth Product	$V_{CE} = 2\text{V}, I_C = 500\text{mA}$		120		MHz
C_{ob}	Output Capacitance	$V_{CB} = 10\text{V}, I_E = 0, f = 1\text{MHz}$		40		pF

* Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

h_{FE} Classification

Classification	O	Y
h _{FE}	100 ~ 200	160 ~ 320

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
2883	KSC2883	SOT-89	13"	--	4,000

Typical Performance Characteristics

Figure 1. Static Characteristic

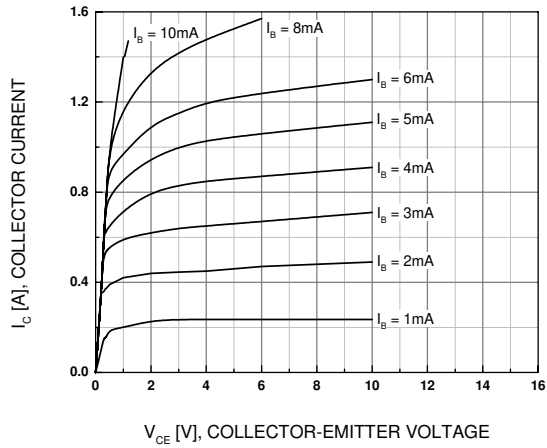


Figure 2. Base-Emitter On Voltage

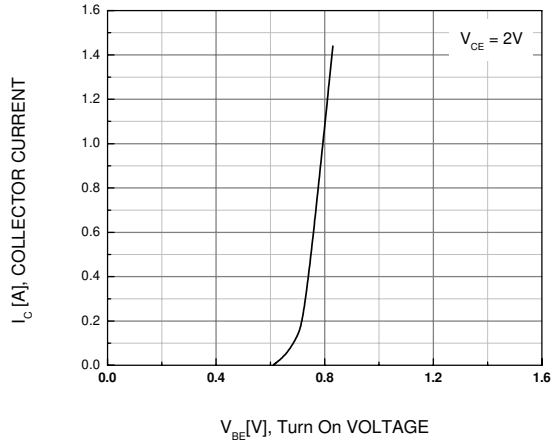


Figure 3. DC Current Gain

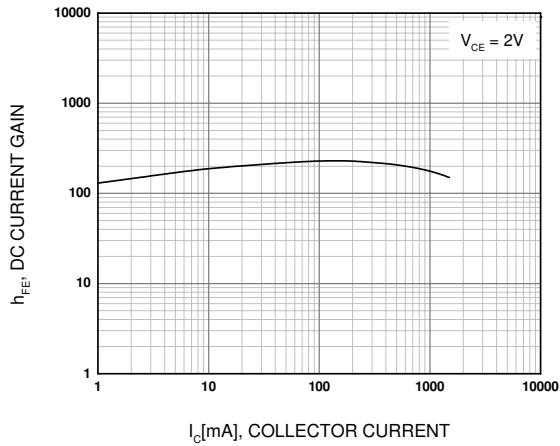


Figure 4. Collector-Emitter Saturation Voltage

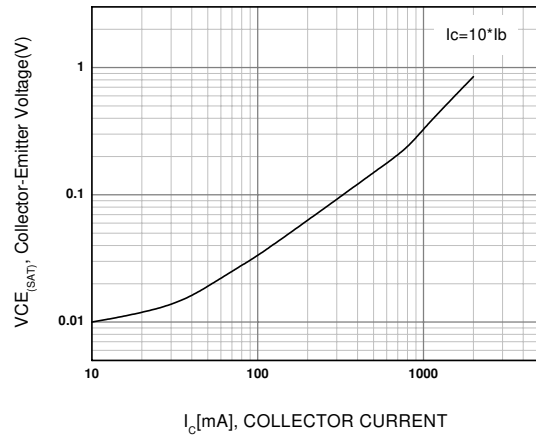


Figure 5. Safe Operating Area

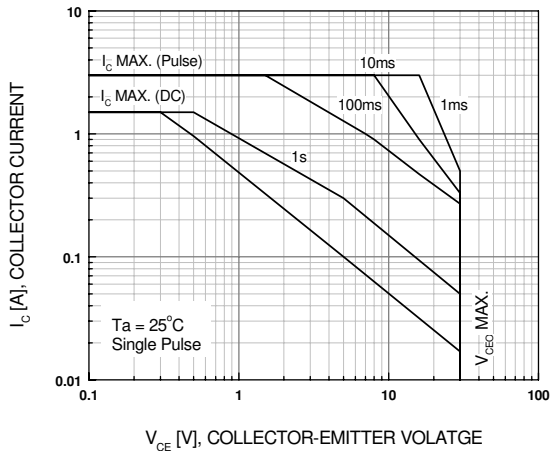
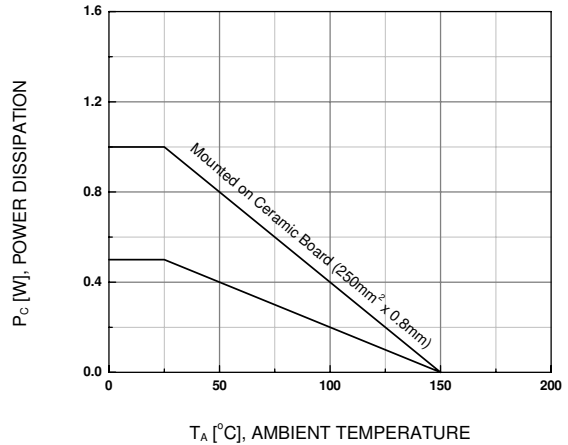
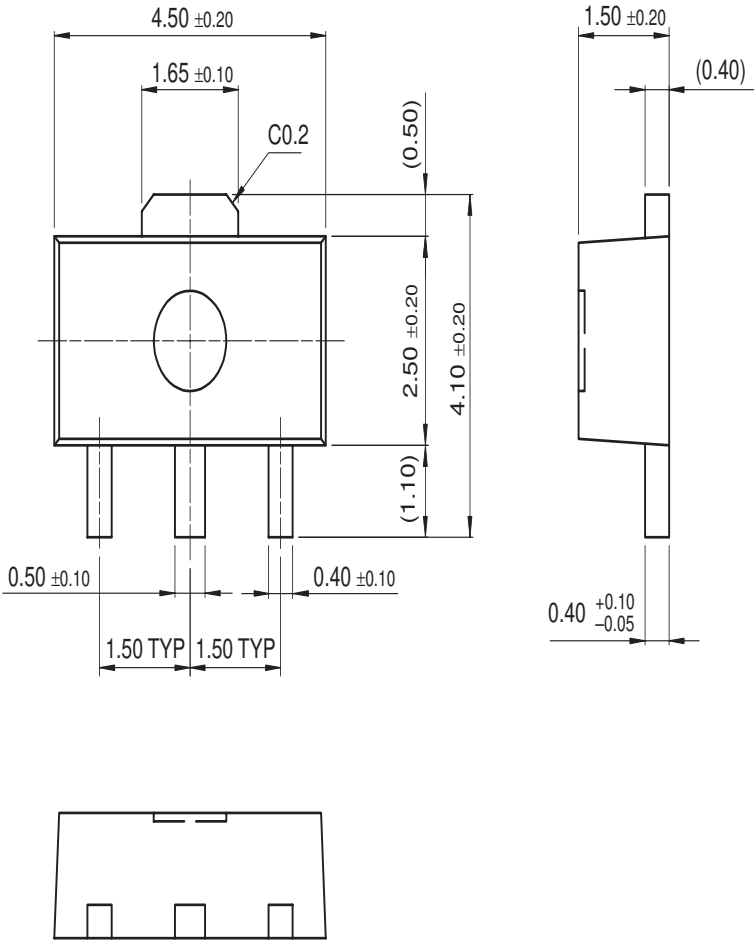


Figure 6. Power Derating



Mechanical Dimensions

SOT-89



Dimensions in Millimeters

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FAST _r ™	MicroPak™	QT Optoelectronics™	TinyPWM™	
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	MSXPro™	RapidConnect™	TINYOPTO™	
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Programmable Active Droop™				

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